

Renesas RA Family

RA AWS MQTT/TLS Cloud Connectivity Solution - Ethernet

Introduction

This application note describes IoT Cloud connectivity solution in general, provides a brief introduction to IoT Cloud providers like Amazon Web Services (AWS), and covers the FSP MQTT/TLS module and its features. The application example provided in the package uses AWS IoT Core. The detailed steps in this document show first-time AWS IoT Core users how to configure the AWS IoT Core platform to run this application example.

This application note enables developers to effectively use the FSP MQTT/TLS modules in end-product design. Upon completion of this guide, developers will be able to add the “AWS Core MQTT”, “Mbed TLS”, and “AWS TCP Sockets Wrapper” using the Ethernet interface, configure them correctly for the target application, and write code using the included application example code as a reference for an efficient starting point.

References to detailed API descriptions, and other application projects that demonstrate more advanced uses of the module, are in the *FSP User's Manual* (available at: <https://renesas.github.io/fsp/>), which serves as a valuable resource in creating more complex designs.

This MQTT/TLS AWS Cloud Connectivity solution is supported on the [CK-RA6M5](#).

Applies to:

RA6M5 MCU Group

Required Resources

To build and run the MQTT/TLS application example, the following resources are needed.

Development tools and software

- Flexible Software Package (FSP) v5.0.0 and required tools (renesas.com/us/en/software-tool/flexible-software-package-fsp)

Hardware

- Renesas CK-RA6M5 kit (renesas.com/ra/ck-ra6m5)
- PC running Windows® 10 and an installed web browser (Google Chrome, Internet Explorer, Microsoft Edge, Mozilla Firefox, or Safari)
- Micro USB cables (included as part of the kit. See *CK-RA6M5 — User's Manual*)
- Ethernet cable
- A router with at least 1 available 100 Mbps/full duplex Ethernet port

Prerequisites and Intended Audience

This application note assumes that the user is adept at operating the Renesas e² studio IDE with Flexible Software Package (FSP). If not, we recommend reading and following the procedures in the *FSP User's Manual* sections for 'Starting Development' including 'Debug the Blinky Project'. Doing so enables familiarization with e² studio and FSP and validates proper debug connection to the target board. In addition, this application note assumes prior knowledge of MQTT/TLS and its communication protocols.

The intended audience is users who want to develop applications with MQTT/TLS modules using Ethernet modules on Renesas RA6 MCU Series.

Note: If you are a first-time user of e² studio and FSP, we highly recommend you install e² studio and FSP on your system to run the Blinky Project and to get familiar with the e² studio and FSP development environment before proceeding to the next sections.

Note: This Application Project and Application Note can only use versions FSP v5.0.0.

Note: If you want to quickly build and run the attached application, please jump to section (2 Running the MQTT/TLS Ethernet Application Example).

Prerequisites

1. Access to online documentation is available in the Cloud Connectivity References section.
2. Access to latest documentation for identified Renesas Flexible Software Package.
3. Prior knowledge of operating e² studio and built-in (or standalone) RA Configurator.
4. Access to associated hardware documentation such as User Manuals, Schematics, and other relevant kit information (renesas.com/ra/ck-ra6m5).

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1. Introduction to Components for Cloud Connectivity

1.1 General Overview

The Internet-of-Things (IoT) is a global infrastructure for the information society, enabling advanced services by interconnecting (physical and virtual) things based on existing and evolving interoperable information and communication technologies. The ‘things’ in this definition are objects in the physical world (physical objects) or information world (virtual) that can be identified and integrated into communication networks. In the context of the IoT, a ‘device’ is a piece of equipment with the mandatory capabilities of communication and the optional capabilities of sensing, actuation, data capture, data storage and data processing. Communication is often performed with providers of network-hosted services, infrastructure, and business applications to process/analyze the generated data and manage the devices. Such providers are called Cloud Service Providers. While there are many manufacturers for devices and cloud service providers, for the context of this application note, the device is a Renesas RA Microcontroller (MCU) connecting to services provided by Amazon Web Services (AWS) for IoT.

1.2 Cloud Service Provider

[AWS IoT](#) provides the cloud services that connect your IoT devices to other devices and AWS cloud services. As a Cloud Service Provider, AWS IoT provides the ability to:

- Connect and manage devices
- Secure device connections and data
- Process and act upon device data
- Read and set device state at any time

Figure 1 summarizes the features provided by AWS IoT.

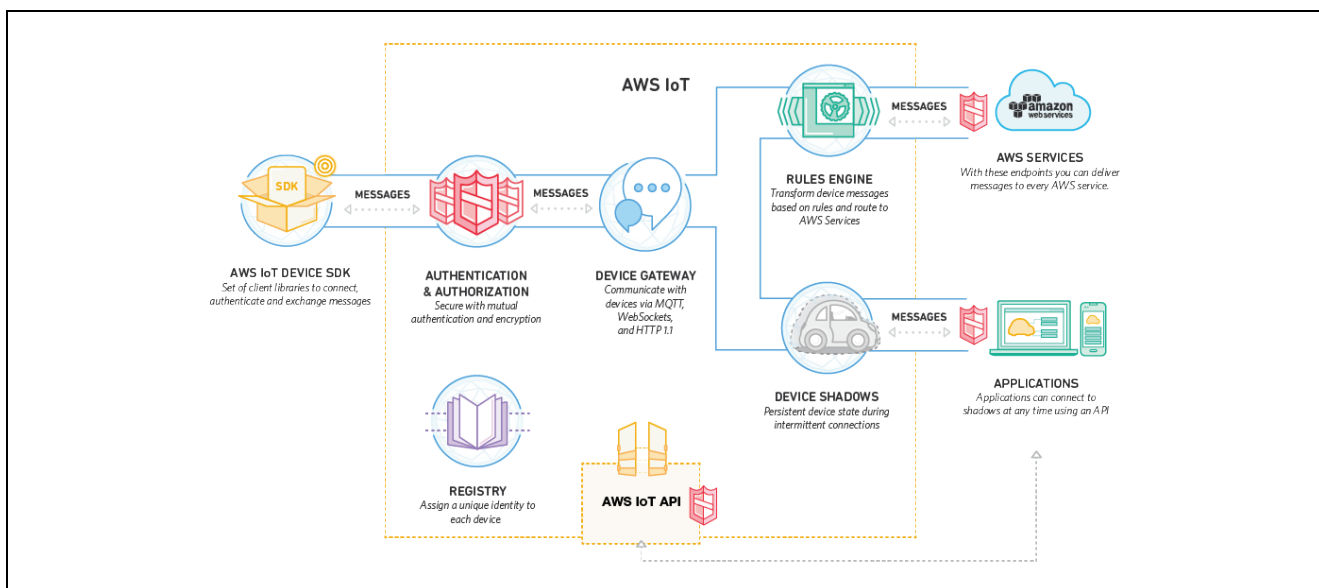


Figure 1. AWS IoT Features, Service Components, and Data Flow Diagram

A key feature provided by AWS is the AWS IoT Software Development Kit (SDK) written in C, which allows devices such as sensors, actuators, embedded micro-controllers, or smart appliances to connect, authenticate, and exchange messages with AWS IoT using the MQTT, HTTP, or WebSocket's protocols. This application note focuses on configuring and using the AWS IoT Device SDK and the included MQTT protocol available through the Renesas Flexible Software Package (FSP) for Renesas RA MCUs.

1.3 Cloud Dashboard

A cloud dashboard is a monitoring and controlling the GUI for the multiple services that you can build and access on a web browser. It has key advantages over on-premises software such as being easier to deploy, requiring little to no IT support and is accessible on multiple devices.

The **Dashboard** provides a high-level view of your entire fleet of devices and allows you to act on individual devices quickly. You can view graphical representations of relevant device information for your fleet, such as device ownership type, compliance statistics, and platform and OS breakdowns. You can access each set of devices in the presented categories by selecting any of the available data views from the **Device Dashboard**.

1.3.1 Data Monitoring

Data monitoring on the dashboard is a cloud data analytics monitoring solution that lets you track your performance metrics and easily visualize your data sets. You will be able to get a high-level view of your metrics, or you can drill down and analyze the detail.

For instance, it can be sensor data coming from the device in the form of temperature, pressure, and so forth.

1.3.2 Device Management

Device Management provides high-level control to configure the devices in bulk for the entire fleet of devices or to control the individual devices.

Note: All the Dashboard-specific details for this Application Project are discussed in the *(RA AWS Cloud Connectivity on CK-RA6M5 with Ethernet – Getting Started Guide)* document.

1.4 AWS IoT Core

[AWS IoT Core](#) is a managed cloud service that lets connected devices easily and securely interact with cloud applications and other devices. AWS IoT Core can support billions of devices and trillions of messages. It can process and route messages to AWS endpoints and to other devices reliably and securely. With AWS IoT Core, customer applications can keep track of all devices, all the time, even when devices are not connected.

AWS IoT Core addresses security concerns for the infrastructure by implementing mutual authentication and encryption. AWS IoT Core provides automated configuration and authentication upon a device's first connection to AWS IoT Core, as well as end-to-end encryption throughout all points of connection, so that data is only exchanged between devices and AWS IoT Core with proven identity.

This application note focuses on complementing the security needs of AWS IoT Core through installing a proven identity for the RA MCU by storing a X.509 certificate and asymmetric cryptography keys in Privacy Enhanced Mail (PEM) format in the on-board flash. The RA MCU has on-chip security features, such as Key Wrapping, to protect the private key associated with the public key and the certificate associated with the device¹. Additionally, RA MCUs can also generate asymmetric keys using features of the Secure Cryptography Engine (SCE) and API available through the FSP. The SCE accelerates symmetric encryption/decryption of data between the connected device and AWS IoT, allowing the ARM Cortex-M processor to perform other application specific computations.

1.5 MQTT Protocol Overview

This application note features Message Queuing Telemetry Transport (MQTT) as it is a lightweight communication protocol specifically designed to tolerate intermittent connections, minimize the code footprint on devices, and reduce network bandwidth requirements. MQTT uses a publish/subscribe architecture which is designed to be open and easy to implement, with up to thousands of remote clients capable of being supported by a single server. These characteristics make MQTT ideal for use in constrained environments

¹ This application note does not focus on using Key Wrapping for securely storing the private key for devices deployed in a production environment.

where network bandwidth is low or where there is high latency and with remote devices that might have limited processing capabilities and memory. The RA MCU device in this application note implements a Core MQTT service which communicates with AWS IoT and exchanges example telemetry information, such as temperature, pressure, humidity, accelerometer, magnetometer and many more types of sensor data.

1.6 TLS Protocol Overview

The primary goal of the Transport Layer Security (TLS) protocol is to provide privacy and data integrity between two communicating applications or endpoints. AWS IoT mandates the use of secure communication. Consequentially, all traffic to and from AWS IoT is sent securely using TLS. TLS protocol version 1.2 or later ensures the confidentiality of the application protocols supported by AWS IoT. A variety of TLS Cipher Suites are supported. This application note configures the RA Flexible Software Package for the MCU based device to provide the following capabilities and AWS IoT negotiates the appropriate TLS Cipher Suite configuration to maximize security.

Table 1. TLS with Crypto Capabilities in RA FSP

Secure Crypto Hardware Acceleration	Supported
Key Format Supported	AES, ECC, RSA
Hash	SHA-256
Cipher	AES
Public Key Cryptography	ECC, ECDSA, RSA
Message Authentication Code (MAC)	HKDF

On top of these supported features, Mbed Crypto middleware also supports a variety of features which can be enabled through the RA Configurator. Refer to the *FSP User's Manual* section for the Crypto Middleware (rm_psa_crypto).

1.7 Device Certificates, CA, and Keys

Device Certificates, Certificate Authorities (CA), and Asymmetric Key Pairs create the foundation for trust needed for a secure environment. The background information on these commonly used components in AWS is provided in this section.

A *digital certificate* is a document in a known format that provides information about the identity of a device. The X.509 standard includes the format definition for public-key certificate, attribute certificate, certificate revocation list (CRL), and attribute certificate revocation list (ACRL). X.509-defined certificate formats (X.509 Certificates) are commonly used on the internet and in AWS IoT for authenticating a remote entity/endpoint, that is, a Client and/or Server. In this application note, an X.509 certificate and asymmetric cryptography key pair (public and private keys) are generated from AWS IoT and installed (during binary compilation) into the RA MCU device running the Core MQTT to establish a *known identity*. In addition, a root Certification Authority (CA) certificate is also downloaded and used by the device to authenticate the connection to the AWS IoT gateway.

Certification authority (CA) certificates are certificates that are issued by a CA to itself or to a second CA for the purpose of creating a defined relationship between the two CAs. The root CA certificate allows devices to verify that they're communicating with AWS IoT Core and not another server impersonating AWS IoT Core.

The public and private keys downloaded from AWS IoT use RSA algorithms for encryption, decryption, signing and verification². These key pairs, and certificates are used together in the TLS process to:

1. Verify device identity.
2. Exchange symmetric keys, for algorithms such as AES, for encrypting and decrypting data transfers between endpoints.

2. Running the MQTT/TLS Ethernet Application Example

Refer to *RA AWS Cloud Connectivity on CK-RA6M5 with Ethernet - Getting Started Guide* as part of this project bundle for details on running the project and visualizing the sensor data on Renesas AWS dashboard.

² Public Key length used is 2048 bits.

3. AWS Core MQTT with Ethernet Interface

3.1 AWS Core MQTT

The AWS MQTT library included in RA FSP can connect to either AWS MQTT or to any third party MQTT broker such as Mosquitto. The complete documentation for the library can be found on the [AWS IoT Device SDK C](#): MQTT website. Primary features supported by the library are:

- MQTT connections over TLS to an AWS IoT Endpoint or Mosquitto server or other MQTT broker.

The AWS Core MQTT can be directly imported into a **Thread** stack. It is configured through the RA Configuration Perspective. To add the AWS Core MQTT to a new thread, open configuration.xml with the RA Configuration. While ensuring that the correct thread is selected on the left, use the tab for **Stacks > New Stack > Search** and search for the keyword AWS Core MQTT.

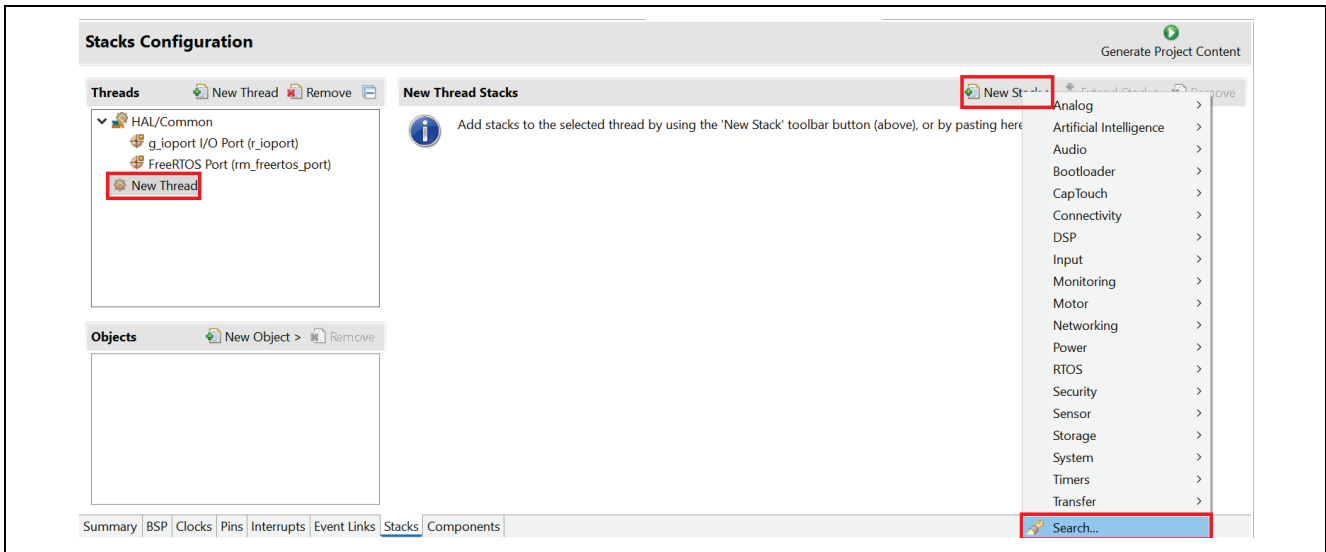


Figure 2. AWS Core MQTT Module Selection

Adding the AWS Core MQTT stack results in the default configuration with *some unmet dependencies*, as shown in the following Figure 3. FSP offers different Transport interfaces to the users. In this application note we will be covering the Ethernet Interface which uses the *AWS Transport Interface on MbedTLS/PKCS11* as shown in the Figure 4.

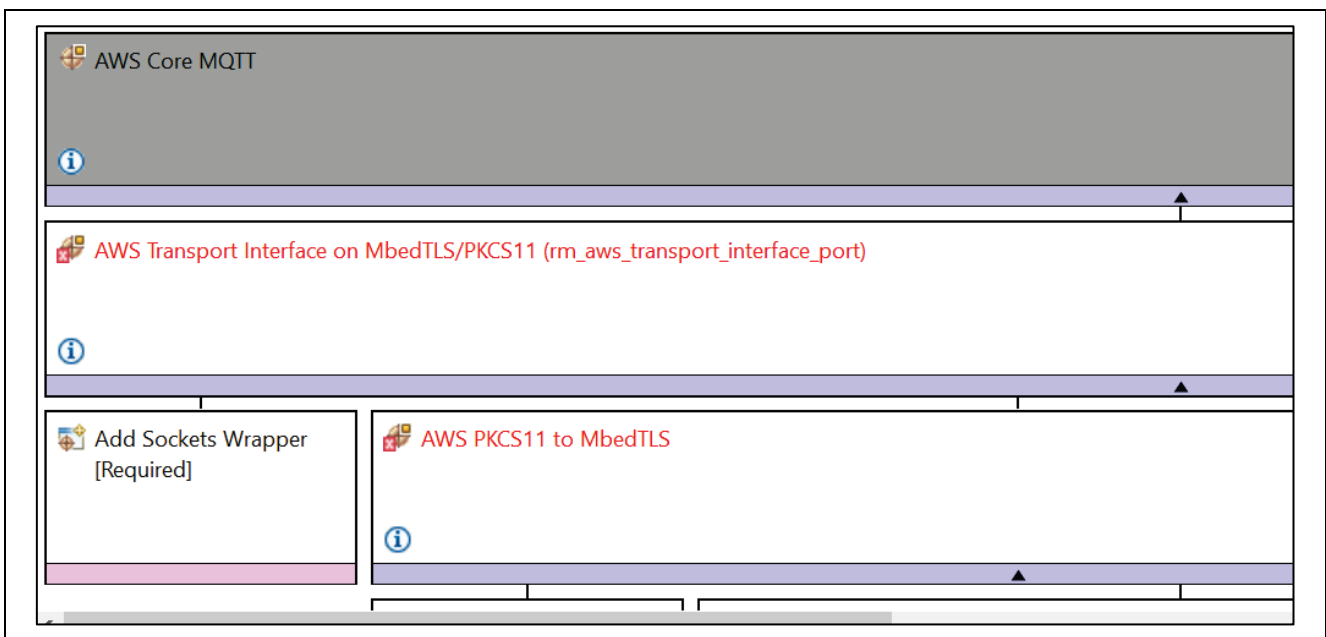


Figure 3. AWS Core MQTT Stack View

While the AWS Core MQTT stack shown contains a lot of dependencies and configurable properties, most default settings can be used as-is. The following change is needed to meet all unmet dependencies (marked in red) for the AWS Core MQTT stack added to a new project (as shown above):

- Enable Mutex and Recursive Mutex usage support as needed by IoT SDK and FreeRTOS in the created Thread properties.

Upon completion of the above step, the AWS Core MQTT is ready to accept a socket implementation, which has dependencies on using a TLS Session and an underlying TCP/IP implementation.

Additional documentation on the AWS Core MQTT is available in the *FSP User's Manual* under *RA Flexible Software Package Documentation > API Reference > Modules > Networking > AWS MQTT*.

3.2 Transport Layer Implementation

The FSP AWS Transport Interface provides options for Wi-Fi, Cellular, and Ethernet. **AWS Transport Interface on MbedTLS/PKCS11** module is used for the Ethernet Interface. While the RA FSP contains a Secure Socket Implementation for Wi-Fi, Cellular and Ethernet, this application and application note focuses on the use of the Ethernet Interface.

Ethernet Sockets can be added to the Thread Stack by clicking on **Add Sockets Wrapper > New > AWS TCP Sockets Wrapper**.

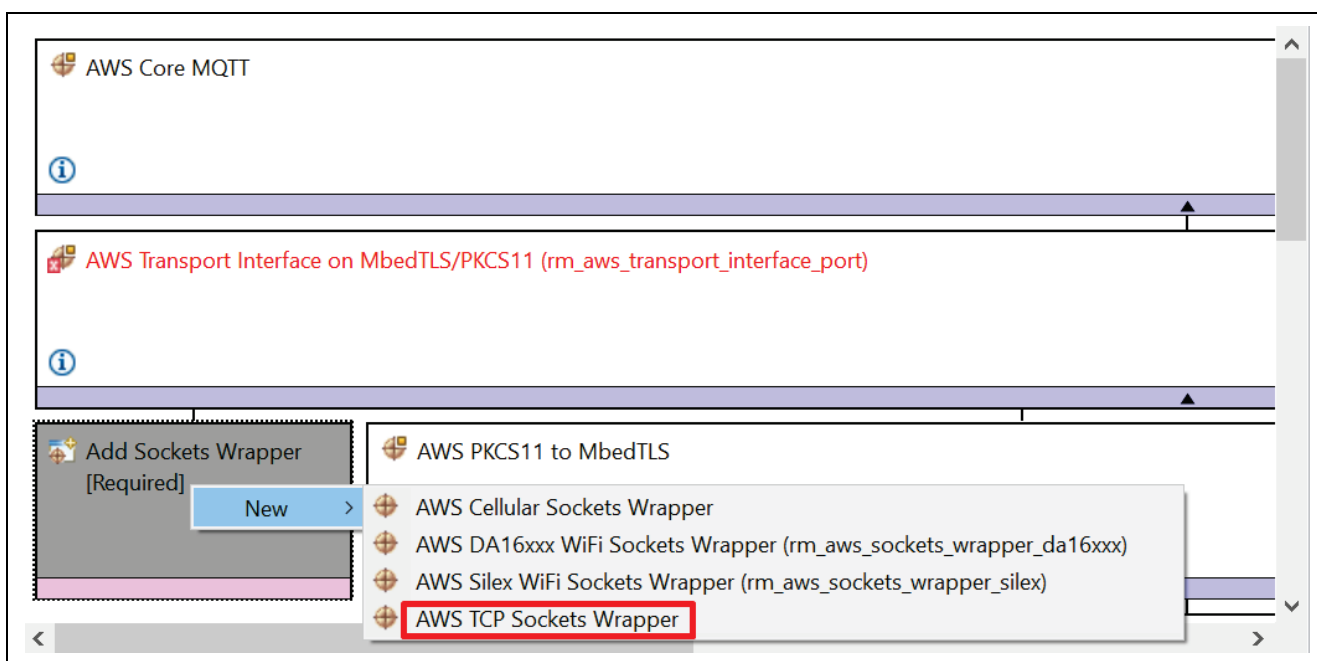


Figure 4. Adding Ethernet Interface to the Core MQTT Module

Upon addition, the needed stack is complete and has unmet dependencies for the dependent modules.

Now, hover the cursor over the red blocks and the error will pop up. Make the appropriate settings.

- **AWS Transport Interface on MbedTLS/PKCS11** errors:
 - For error: *Requires FreeRTOS heap implementation 4 or 5*, choose the heap implementation using **New Stack > RTOS > FreeRTOS Heap 4**. Also, set **Dynamic Memory allocation** in Thread's properties: using **New Thread > Properties > Common > Memory Allocation > Support Dynamic Allocation > Enabled**.
 - For error: *Mutexes must be enabled in the FreeRTOS thread*, enable mutexes in Thread's properties: using **New Thread > Properties > Common > General > Use Mutexes > Enabled**.
- For **AWS PKCS11 to MbedTLS** error: *MBEDTLS_CMAC_C must be defined*, using **MbedTLS (Crypto Only) > Common > Message Authentication Code (MAC) > MBEDTLS_CMAC_C > Define**.
- For **MbedTLS** error: *MBEDTLS_ECDH_C must be defined*, using **MbedTLS (Crypto Only) > Common > Public Key Cryptography (PKC) > ECC > MBEDTLS_ECDH_C > Define**.
- **MbedTLS (Crypto Only)** errors relate to minimum RTOS heap, set Heap Memory allocation using **New Thread > Properties > Common > Memory Allocation > Total Heap Size > 0x20000**.

- For **LittleFS error**: A heap is required to use *Malloc*, add heap under **BSP Tab > Properties > RA Common > Heap size (bytes) > 0x20000**.
- Mutexes must be enabled using **New Thread > Common > General > Use Mutexes > Enabled**.
- Mutexes must be enabled using **New Thread > Common > General > Use Recursive Mutexes > Enabled**.

Note: These are the basic settings required to remove the error from the configurator. More specific configurations are listed in the specific module and its usage.

After all the appropriate settings have taken care of the errors due to the missing configuration, the new configurator screenshot looks clean with no errors as shown in the Figure 5.

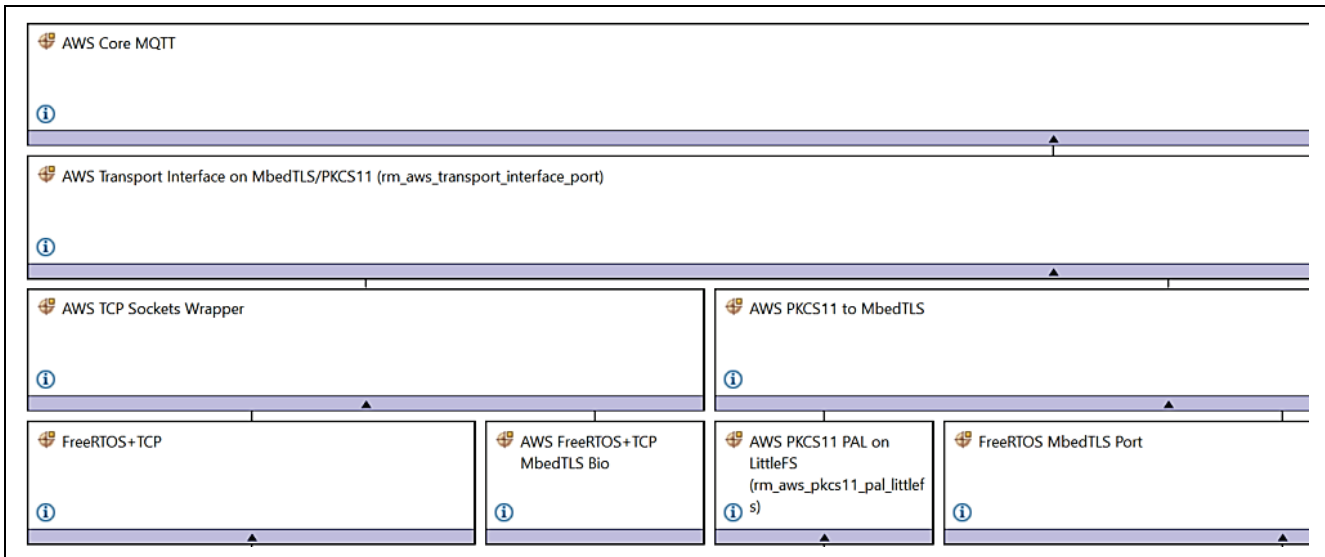


Figure 5. Expanded TCP Socket Interface Module

Additional documentation on AWS Secure Sockets is available in the *FSP User's Manual* under *RA Flexible Software Package Documentation > API Reference > Modules > AWS Secure Sockets*.

3.3 Mbed TLS

Mbed TLS is Arm®'s implementation of the TLS protocols as well as the cryptographic primitives required by those implementations. Mbed TLS is also solely used for its cryptographic features even if the TLS/SSL portions are not used.

TLS Support uses FreeRTOS+Crypto which eventually uses Mbed TLS. Use of Mbed TLS requires configuration and operation of the Mbed Crypto module which in turn operates the SCE on the MCU.

The following underlying mandatory changes are needed to the project using the TCP Sockets on FreeRTOS+Crypto module:

1. Use FreeRTOS heap implementation scheme 4 (first fit algorithm with coalescence algorithm) or scheme 5 (first fit algorithm with coalescence algorithm with heap spanning over multiple non-adjacent/non-contiguous memory regions).
2. Enable support for dynamic memory allocation in FreeRTOS.
3. Enable Mbed TLS platform memory allocation layer.
4. Enable the Mbed TLS generic threading layer that handles default locks and mutexes for the user and abstracts the threading layer to use an alternate thread-library.
5. Enable Elliptic Curve Diffie Hellman (ECDH) library.
6. Change FreeRTOS Total Heap Size to a value greater than or equal to 0x20000.
7. Add Persistent Storage on LittleFS.

Additional documentation on the Mbed TLS is available in the *FSP User's Manual* under *RA Flexible Software Package Documentation > API Reference > Modules > Security > Mbed Crypto H/W Acceleration (rm_psa_crypto)*.

3.4 MQTT Module APIs Usage

Table 2 lists APIs provided by AWS Core MQTT that are used as a part of the Application Example.

Table 2. MQTT Module APIs

API	Description
MQTT_Init	Initializes an MQTT context
MQTT_Connect	Establishes an MQTT session
MQTT_Subscribe	Sends MQTT SUBSCRIBE for the given list of topic filters to the broker
MQTT_Publish	Publishes a message to the given topic name
MQTT_Ping	Sends an MQTT PINGREQ to broker
MQTT_Unsubscribe	Sends MQTT UNSUBSCRIBE for the given list of topic filters to the broker
MQTT_Disconnect	Disconnect an MQTT session
MQTT_ProcessLoop	Loop to receive packets from the transport interface. Handles keep-alive
MQTT_ReceiveLoop	Loop to receive packets from the transport interface. Does not handle keep-alive
MQTT_GetPacketId	Get a packet ID that is valid according to the MQTT 3.1.1 specification.
MQTT_MatchTopic	A utility function that determines whether the passed topic filter and topic name match according to the MQTT 3.1.1 protocol specification.
MQTT_GetSubAckStatusCodes	Parses the payload of an MQTT SUBACK packet that contains status codes corresponding to topic filter subscription requests from the original subscribe packet
MQTT_Status_strerror	Error code to string conversion for MQTT statuses.

4. Cloud Connectivity Application Example

4.1 Overview

This application project demonstrates the use of APIs available through the Renesas FSP-integrated modules for Amazon IoT SDK C, Mbed TLS module, Amazon FreeRTOS, and HAL Drivers operating on Renesas RA MCUs. Network connectivity is established using an Ethernet module. The application running on a Renesas Cloud Kit also serves as a guide for the operation of Core MQTT, Mbed TLS/Crypto, and Ethernet configuration, using the FSP configurator. The application may be used as a starting point for inspiring other customized cloud-based solutions using Renesas RA MCUs. In addition, it simply demonstrates the operation and setup of cloud services available through the cloud service provider.

The upcoming sub-sections show step-by-step creation of a device and security credentials policies as required by the AWS IOT on the cloud side to communicate with the end devices. The example accompanying this documentation demonstrates the Subscribe and Publish messaging between Core MQTT and MQTT Broker, on demand publication of sensor data, and asynchronous publication of a “sensor data” event from the MCU to the Cloud. The device is also subscribed to receive actuation events (LED indication) from the Cloud.

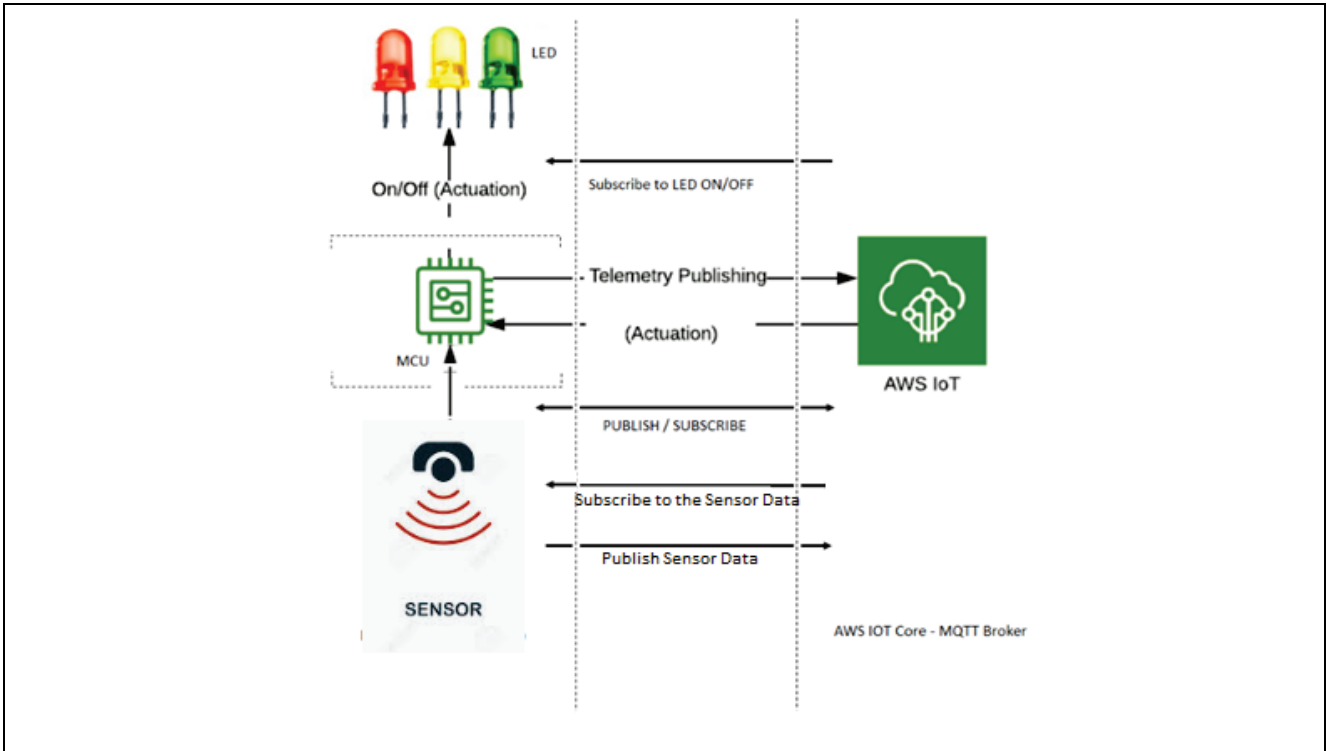


Figure 6. MQTT Publish/Subscribe to/from AWS IoT Core

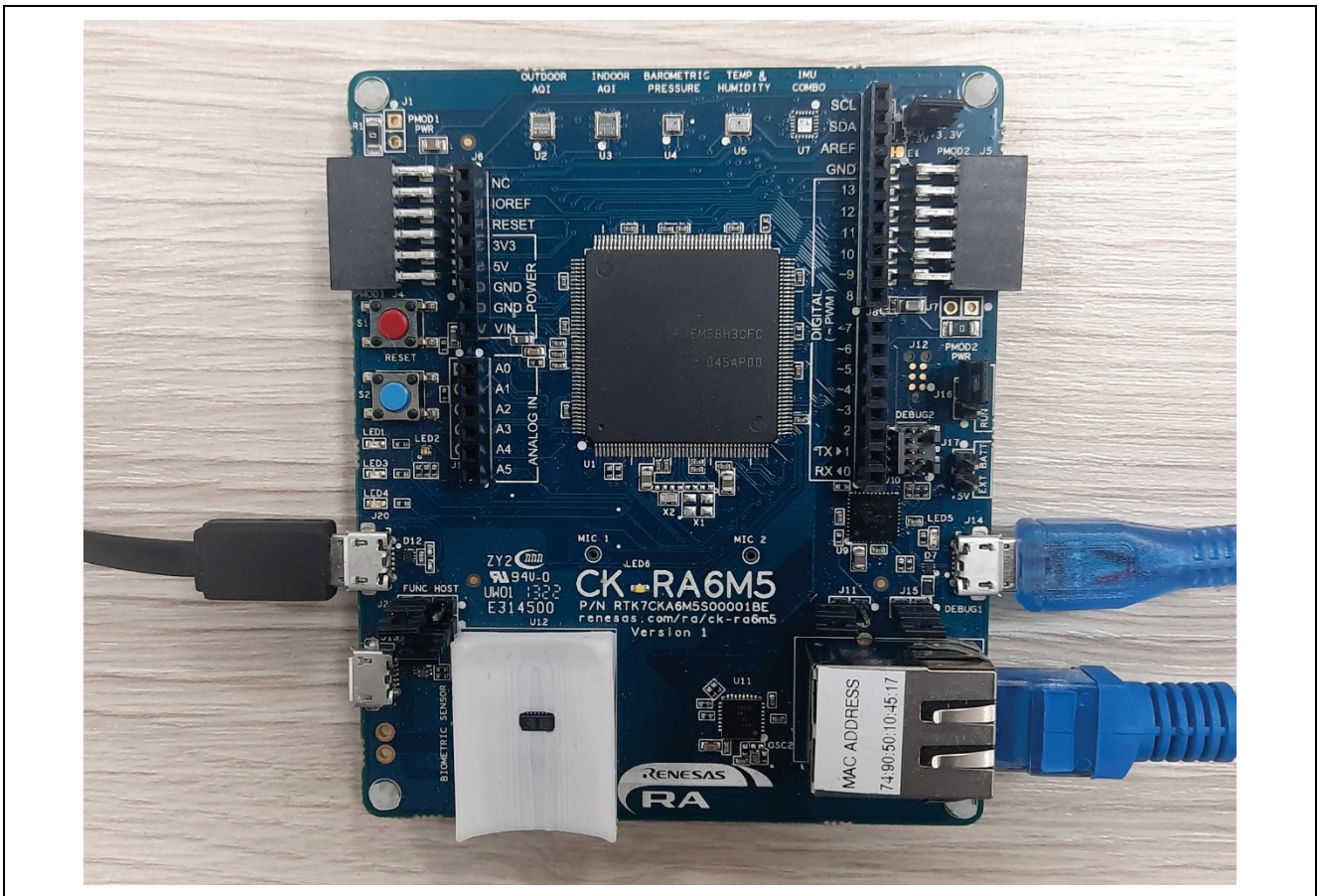


Figure 7. Hardware Setup

4.2 MQTT/TLS Application Software Overview

The following files from this application project serve as a reference, as shown in Table 3.

Table 3. Application Project Files

No.	Filename	Purpose
1.	src/app_thread_entry.c	Contains initialization code and has the main thread used in Cloud Connectivity application.
2.	src/common_init.c	Contains code used to initialize common peripherals across the project.
3.	src/common_init.h	Contains macros, data structures, and functions prototypes used to initialize common peripherals across the project.
4.	src/common_utils.c	Contains code commonly used across the project.
5.	src/common_utils.h	Contains macros, data structures, and functions prototypes commonly used across the project.
6.	src/console_thread_entry.c	Contains the code for command line interface and flash memory operations.
7.	src/icm.h	Contains user defined data types and function prototypes which have implementation in RA_ICM20948.c
8.	src/ICM20948.c	Contains driver codes for the 9 Axis sensor (Gyroscope, Accelerometer, Magnetometer)
9.	src/ICM20948.h	Contains the Data structure function prototypes for the 9 Axis sensor (Gyroscope, Accelerometer, Magnetometer)
10.	src/ICP_10101.c	Contains the driver codes for Barometric Pressure and Temperature Sensor.
11.	src/ICP_10101.h	Contains the Data structure and function prototypes for Barometric Pressure and Temperature Sensor
12.	src/icp.h	Contains user defined data types and function prototypes which have implementation in RA_ICP10101.c
13.	src/mqtt_demo_helpers.c	Contains code and functions used in MQTT interface for Cloud Connectivity.
14.	src/mqtt_demo_helpers.h	Accompanying header for exposing functionality provided by mqtt_demo_helpers.c.
15.	src/oximeter_thread_entry.c	Contains codes for oximeter sensor thread's operation.
16.	src/oximeter.c	Contains codes for oximeter sensor's initialization and measurement.
17.	src/oximeter.h	Contains the Data structure and function prototypes for the oximeter sensor.
18.	src/r_typedefs.h	Contains the common derived data types
19.	src/RA_HS3001.c	Contains the code and function for Renesas Relative Humidity and Temperature Sensor.
20.	src/RA_HS3001.h	Contains the common data structure's function prototypes for the Renesas Relative Humidity and Temperature sensors.
21.	src/RA_ICM20948.c	Contains codes for 9 Axis sensor (Gyroscope, Accelerometer, Magnetometer) sensor's initialization and measurement.

No.	Filename	Purpose
22.	src/RA_ICP10101.c	Contains codes for Barometric Pressure and Temperature sensor's initialization and measurement.
23.	src/RA_ZMOD4XXX_Common.c	Contains the common code for the Renesas ZMOD sensors
24.	src/RA_ZMOD4XXX_Common.h	Contains the common data structure's function prototypes for the Renesas ZMOD sensors
25.	src/RA_ZMOD4XXX_IAQ1stGen.c	Contains the common code for the Renesas ZMOD Internal Air Quality sensors
26.	src/RA_ZMOD4XXX_OAQ1stGen.c	Contains the common code for the Renesas ZMOD Outer Air Quality sensors
27.	src/RmcI2C.c	Contains the I2C wrapper functions for the third-party sensors not integrated with FSP
28.	src/RmcI2C.h	Contains the I2C function prototypes for wrapper functions for the third-party sensors not integrated with FSP
29.	src/sensor_thread_entry.c	Contains the Code to access the Sensor data from the different sensors and order topic to publish.
30.	src/user_choice.c	Contains the code for user's choice of sensors and user configurations
31.	src/user_choice.h	Contains the Function prototypes for the Sensor and its user configuration for the different sensors and its data accessibility.
32.	src/usr_config.h	To customize the user configuration to run the application.
33.	src/usr_data.h	Accompanying header file for the application thread.
34.	src/usr_hal.c	Contains data structures and functions used for the Hardware Abstraction Layer (HAL) initialization and associated utilities.
35.	src/usr_hal.h	Accompanying header for exposing functionality provided by <code>usr_hal.c</code> .
36.	src/usr_network.c	Contains data structures and functions used in FreeRTOS TCP/IP and Ethernet Module.
37.	src/usr_network.h	Contains declarations of data structures and functions used in <code>usr_network.c</code>
38.	src/zmod_thread_entry.c	Contains the code for indoor air and outdoor air quality sensors
39.	src/SEGGER_RTT/SEGGER_RTT.c	Implementation of SEGGER real-time transfer (RTT) which allows real-time communication on targets which support debugger memory accesses while the CPU is running.
40.	src/SEGGER_RTT/SEGGER_RTT.h	
41.	src/SEGGER_RTT/SEGGER_RTT_Conf.h	
42.	src/SEGGER_RTT/SEGGER_RTT_printf.c	
43.	src/backoffAlgorithm/backoff_algorithm.c	Retry algorithms with random back off for the next retry attempt
44.	src/backoffAlgorithm/backoff_algorithm.h	Retry algorithms with random back off for the next retry attempt header file
45.	src/subscription_manager/mqtt_subscription_manager.c	MQTT Subscription manager, which handles the callback
46.	src/subscription_manager/mqtt_subscription_manager.h	Associated header file for MQTT Subscription manager, which handles the callback.
47.	src/console_menu/console.c	Contains data structures and functions used to print data on console using UART

No.	Filename	Purpose
48.	src/console_menu/console.h	Contains the Function prototypes used to print data on console using UART
49.	src/console_menu/menu_flash.c	Contains data structures and functions used to provide CLI flash memory related menu
50.	src/console_menu/menu_flash.h	Contains the Function prototypes and macros used to provide CLI flash memory related menu
51.	src/console_menu/menu_kis.c	Contains functions to get the FSP version, get UUID and help option for main menu on CLI
52.	src/console_menu/menu_kis.h	Contains the function prototypes and macros used to get FSP version, get UUID and help option for main menu on CLI
53.	src/console_menu/menu_main.c	Contains data structures and functions used to provide CLI main menu options
54.	src/console_menu/menu_main.h	Contains the Function prototypes and macros used to provide CLI main menu options
55.	src/flash/flash_hp.c	Contains data structures and functions used to perform flash memory related operations
56.	src/flash/flash_hp.h	Contains the Function prototypes and macros used to perform flash memory related operations
57.	src/I2C/i2c.c	Contains data structures and functions used for I2C communication
58.	src/I2C/i2c.h	Contains the Function prototypes and macros used for I2C communication
59.	src/ob1203_bio/KALMAN/kalman.c	Contains algorithm for Heart Rate, Blood Oxygen Concentration, Pulse Oximetry, Proximity, Light and Color Sensor sample calculations
60.	src/ob1203_bio/KALMAN/kalman.h	
61.	src/ob1203_bio/SAVGOL/SAVGOL.c	
62.	src/ob1203_bio/SAVGOL/SAVGOL.h	
63.	src/ob1203_bio/SPO2/SPO2.c	
64.	src/ob1203_bio/SPO2/SPO2.h	
65.	src/ob1203_bio/ob1203_bio.c	Contain codes for ob1203 sensor's implementation to use with FSP stacks.
66.	src/ob1203_bio/ob1203_bio.h	Contain user data structure and function prototypes used in ob1203_bio.c
67.	src/hal_entry.c	Contains hal level functions used in the application

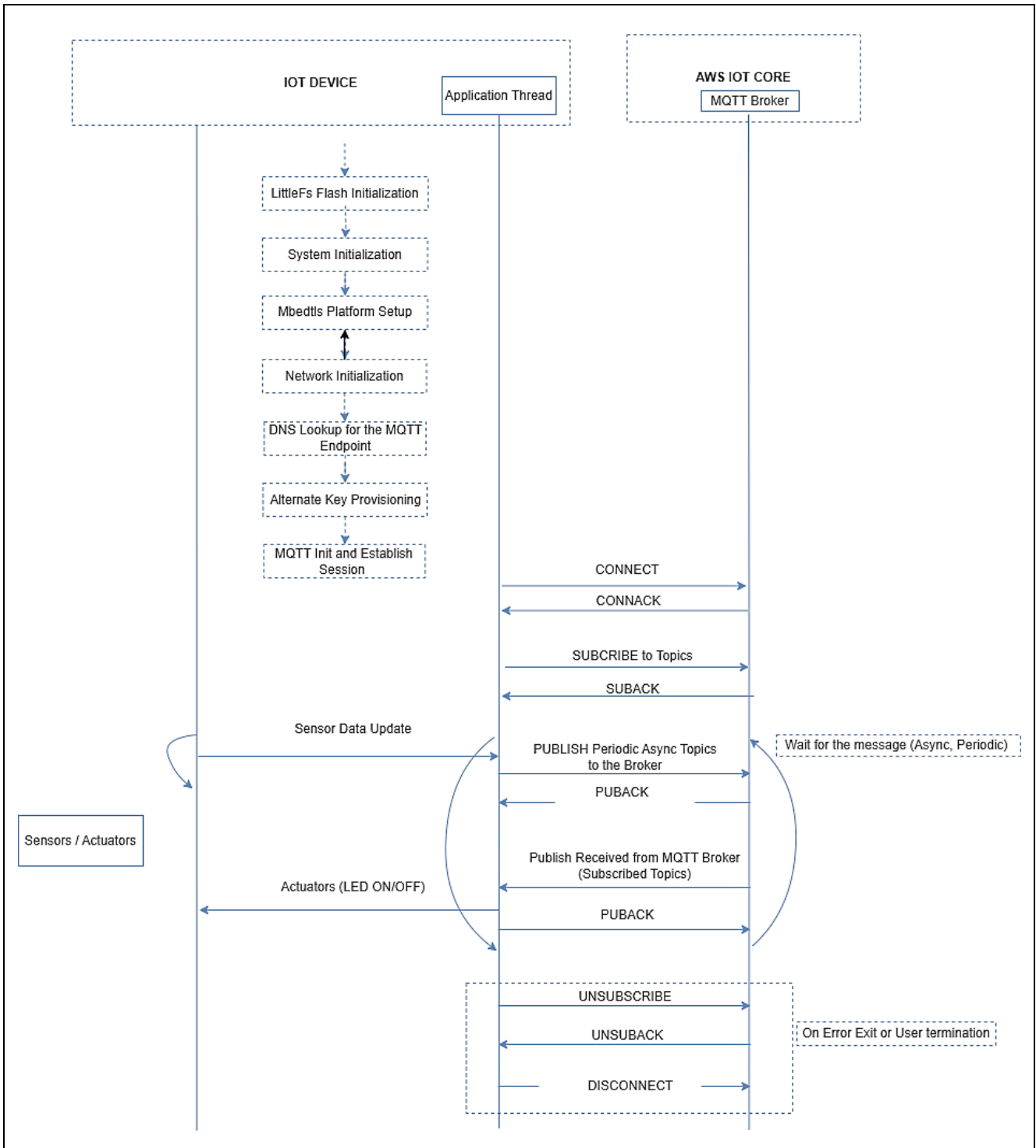


Figure 8. Application Example Implementation Details

4.3 Creating the Application Project Using the FSP Configurator

Complete steps to create the project from the start using the e² studio and FSP configurator. Table 4 shows the step-by-step process in creating the project. It is assumed that the user is familiar with the e² studio and FSP configurator. Launch the installed e² studio for the FSP.

Table 4. Step-by-step Details for Creating the Application Project for Ethernet

Steps	Intermediate Steps
1	Project Creation: File → New → C/C++ Project

	Steps	Intermediate Steps
2	Project Template:	Templates for New RA C/C++ Project → Renasas RA C/C++ Project → Next
3	e² studio - Project Configuration (RA C Executable Project) →	Project Name (Name for the Project) Note: Input your desired name for the project -> Next
4	Device Selection →	FSP Version: 5.0.0
		Board: CK-RA6M5
		Device: R7FA6M5BH3CFC
		Language: C
5	Select Tools	Toolchain: GNU ARM Embedded (Default)
		Toolchain version: (12.2.1.arm-12-mpacbti-34 or newer)
		Debugger: J-Link ARM → Next
5a	Project Type Selection	Flat (Non-TrustZone) Project → Next
6	Build Artifact and RTOS Selection	Artifact Selection: Executable
		RTOS Selection: FreeRTOS(v10.6.1+fsp5.0.0) → Next
6a	Project Template Selection	Project Template Selection: FreeRTOS – Minimal – Static Allocation → Finish
7	Clocks tab	HOCO 20MHz →PLL Src: HOCO → PLL Div/2 →PLL Mul x20.0 → PLL 200MHz
8	Create and configure for App Thread	
	Stacks Tab→	Threads → New Thread
	Config Thread Properties→	Symbol: app_thread
		Name: App Thread
		Stack size (bytes): 0x12000
		Priority: 3
		Thread Context: NULL
Memory Allocation: Static		
8a	Generic RTOS configs under thread (Additional configuration on top of the Default Config provided by FSP)	
	Common → General	Use Mutexes: Enabled
		Use Recursive Mutexes: Enabled
	Common → Memory Allocation	Support Dynamic Allocation: Enabled
		Total Heap Size: 0x20000
9	Add the Heap Implementation in HAL/Common	
	New Stack →	RTOS → FreeRTOS Heap 4
10	Adding the AWS MQTT Wrapper Module to the Application Thread	
	Note: Now the Newly created thread (Application thread) is ready to add new stack (Here the AWS Core MQTT is added)	
	New Stack →	Networking → AWS Core MQTT
10a	Under the AWS Transport Interface on MbedTLS/PKCS11 → Add Sockets Wrapper , add	New → AWS TCP Sockets Wrapper
10b	Under the SCE Compatibility Mode → Add Key Injection for PSA Crypto (Optional) , add	New → Key Injection for PSA Crypto
10c	AWS Core MQTT →	Common → Retry count for reading CONNACK from network → 10
11	Adding persistent storage support for AWS PKCS11 and resolve the error in the configurator by selecting the Heap size in the BSP Tab.	

	Steps	Intermediate Steps
	Under the MbedTLS (Crypto only) → Add Persistent Storage on LittleFS (Optional) →	Use → LittleFS
	LittleFS on Flash →	Block count → (BSP_DATA_FLASH_SIZE_BYTES/256)
	BSP Tab → RA Common →	Heap size (bytes): 0x20000
12	Some dependency related to TLS Support are needed to be resolved to remove the error in the FSP configurator by modifying the MbedTLS (Crypto Only) property settings.	
	Common → Platform →	MBEDTLS_PLATFORM_MEMORY: Define
	Common → General →	MBEDTLS_THREADING_C: Define
	Common → General →	MBEDTLS_THREADING_ALT: Define
	Common → Public Key Cryptography (PKC) →	ECC → MBEDTLS_ECDH_C: Define
	Common → Hardware acceleration → Public key cryptography (PKC)	RSA 3072 verify: Enabled
	Common → Hardware acceleration → Public key cryptography (PKC)	RSA 4096 verify: Enabled
	Common → Storage →	MBEDTLS_FS_IO: Define
	Common → Storage →	MBEDTLS_PSA_CRYPTO_STORAGE_C: Define
	Common → Storage →	MBEDTLS_PSA_ITS_FILE_C: Define
	Common → Message Authentication Code (MAC) →	MBEDTLS_CMAC_C: Define
13	FreeRTOS + TCP Configuration Note: This is only applicable for the Ethernet application project. Most of the default settings remain the same, except few of the default configuration needs to be change	
	Common →	DHCP callback function: Enable
		Stack size in words: configMINIMAL_STACK_SIZE * 16
		DNS request attempts: 6
		Set the maximum number of events: ipconfigNUM_NETWORK_BUFFER_DESCRIPTOR + 16
		Size of Rx buffer for TCP sockets: 8192
		Size of Tx buffer for TCP sockets: 8192
	Properties setting for g_ether0 Ethernet → Module g_ether0 Ethernet (r_ether) → Buffers →	Number of TX buffers: 8 Number of RX buffers: 8
	Interrupts →	Interrupt priority: Priority 5
	Properties setting for g_ether_phy0 Ethernet → Common	ICS1894 target: Enabled Reference clock: Enabled
	→ Module g_ether_phy0 Ethernet	PHY-LSI Address: 5
14	Configure Pins for CGC	
	Pins Tab → Pin Selection → Peripherals → System: CGC → CGC0 →	Operation Mode: Main+Sub Osc
15	Adding the HAL Modules as required for the Application Project: Clock Generation Circuit and GPT Timer1 for control publishing sensor value into MQTT	
	HAL/Common Stacks → New Stack	→ System → Clock Generation Circuit (r_cgc)
	Module g_cgc0 Clock Generation Circuit (r_cgc)	Name: g_cgc0
	Pin →	EXTAL: P212 XTAL: P213
	HAL/Common Stacks → New Stack	→ Timers → Timer, General PWM (r_gpt)
	Module Timer, General PWM (r_gpt) → General	Name: g_timer1 Channel: 1

	Steps	Intermediate Steps
		Mode: Periodic
		Period: 1
		Period Unit: Seconds
	Interrupts:	Callback: g_user_timer_cb
		Overflow/Crest Interrupt Priority: Priority 5
	HAL/Common Stacks → New Stack	→ Timers → Timer, General PWM (r_gpt)
	Module Timer, General PWM (r_gpt) → General	Name: g_timer2
		Channel: 2
		Mode: Periodic
		Period: 1
		Period Unit: Milliseconds
	Interrupts:	Callback: TimerCallback
		Overflow/Crest Interrupt Priority: Priority 6
16	Modifying the BSP Settings - RA Common for (Main stack, Heap and Subclock Settings)	
	BSP Tab → Property Settings for RA Common	Main stack size (bytes): 0x2000
		Heap size (bytes): 0x20000
		Subclock Populated: Not Populated
17	Adding FreeRTOS Objects for the Application and Sensors	
	Stacks Tab → Objects →	New Object → Queue
	Property Settings for the Queue	Symbol: g_topic_queue
		Item Size (Bytes): 65
		Queue Length (Items): 16
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Mutex
	Property Settings for the Mutex	Symbol: g_sens_data_mutex
		Type: Mutex
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Binary Semaphore
	Property Settings for the Semaphore	Symbol: g_console_binary_semaphore
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Mutex
	Property Settings for the Mutex	Symbol: g_console_out_mutex
		Type: Mutex
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Mutex
	Property Settings for the Mutex	Symbol: g_update_console_event
		Type: Mutex
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Binary Semaphore
	Property Settings for the Semaphore	Symbol: g_ob1203_semaphore
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Queue
	Property Settings for the Queue	Symbol: g_hs3001_queue
		Item Size (Bytes): 8
		Queue Length (Items): 1
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Queue
	Property Settings for the Queue	Symbol: g_iaq_queue
		Item Size (Bytes): 12
		Queue Length (Items): 1
		Memory Allocation: Static

	Steps	Intermediate Steps
	Stacks Tab → Objects →	New Object → Queue
	Property Settings for the Queue	Symbol: g_oaq_queue
		Item Size (Bytes): 4
		Queue Length (Items): 1
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Queue
	Property Settings for the Queue	Symbol: g_icm_queue
		Item Size (Bytes): 72
		Queue Length (Items): 1
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Queue
	Property Settings for the Queue	Symbol: g_icp_queue
		Item Size (Bytes): 16
		Queue Length (Items): 1
		Memory Allocation: Static
	Stacks Tab → Objects →	New Object → Queue
Property Settings for the Queue	Symbol: g_ob1203_queue	
	Item Size (Bytes): 10	
	Queue Length (Items): 1	
	Memory Allocation: Static	
18	Add Sensors Thread, this thread used to access sensor's values of HS3001, ICP-10101 and ICM-20948; and prepare topics to publish message via using timer1 and g_topic_queue.	
Stacks Tab → Threads	New Thread	
	Config Thread Properties →	
	Symbol: sensor_thread	
	Name: Sensor Thread	
	Stack size (bytes): 8192	
	Priority: 4	
Thread Context: NULL		
Memory Allocation: Static		
18a	Adding the HS300X Temperature/Humidity Sensor Module to the Sensor Thread	
New Stack →	Sensor → HS300X Temperature/Humidity Sensor	
	Config HS300X Temperature/Humidity sensor →	
Name: g_hs300x_sensor0		
Callback: hs300x_callback		
Under I2C Shared Bus → Add I2C Communications Peripheral →	New → I2C Master(r_iic_master)	
Config for I2C Master →	Name: g_i2c_master0	
	Channel: 0	
	Rate: Fast-mode	
	Interrupt Priority Level: Priority 5	
18b	Adding ICP-10101 and ICM-20948 sensors to the Sensor Thread. Note: FSP doesn't provide an integrated module for ICP-10101 and ICM-20948 sensors. This needs to be integrated via the i2c communication device and external IRQ manually. Also, its related sensor driver code needs to be added to the src folder.	
New Stack →	Connectivity → I2C Communication Device	
	Config I2C Communication Device →	
Name: g_comms_i2c_device4		
Slave Address: 0x63		
Callback: ICP_comms_i2c_callback		
Under the I2C Communication Device → Add I2C Shared Bus →	Use → g_comms_i2c_bus0 I2C Shared Bus	
18c	Adding I2C Communication Device and External IRQ for ICM-20948 into Sensor Thread	

	Steps	Intermediate Steps
	New Stack →	Connectivity → I2C Communication Device
	Config I2C Communication Device →	Name: g_comms_i2c_device5
		Slave Address: 0x68
		Callback: ICM_comms_i2c_callback
	Under the I2C Communication Device → Add I2C Shared Bus →	Use → g_comms_i2c_bus0 I2C Shared Bus
18d	Adding the ZMOD4XXX sensor module (ZMOD4510 OAQ) to the Sensor Thread	
	New Stack →	Sensor → ZMOD4XXX Gas Sensor
	Config ZMOD4XXX Gas sensor →	Name: g_zmod4xxx_sensor1
		Callback: zmod4xxx_comms_i2c1_callback
		IRQ Callback: zmod4xxx_irq1_callback
	Under the ZMOD4XXX Gas Sensor → Add Requires ZMOD Library →	New → ZMOD4510 OAQ 1st Generation
	Under the ZMOD4510 OAQ 1st Generation → I2C Communication Device →	Name: g_comms_i2c_device2
	Under the I2C Communication Device → Add I2C Share Bus →	Use → g_comms_i2c_bus0 I2C Shared Bus
	Under the ZMOD4XXX Gas Sensor → Add IRQ Driver for measurement [optional] →	New → External IRQ
	Config External IRQ	Name: g_external_irq1
		Channel: 15
		Trigger: Falling
		Pin Interrupt Priority: Priority 12
19	Add Oximeter Thread for OB1203 sensor' handling.	
	Stacks Tab → Threads	New Thread
	Config Thread Properties →	Symbol: oximeter_thread
		Name: Oximeter Thread
		Stack size (bytes): 2048
		Priority: 4
		Thread Context: NULL
		Memory Allocation: Static
19a	Add the OB1203 sensor module, PPG mode to the Oximeter Thread.	
	New Stack →	Sensor → OB1203 Light/Proximity/PPG Sensor
	Config OB1203 Light/Proximity/PPG Sensor →	Name: g_ob1203_sensor0
	Under the OB1203 Light/Proximity/PPG Sensor → Add Requires OB1203 Operation mode →	New → OB1203 PPG mode
	Under the OB1203 PPG mode → I2C Communication Device →	Name: g_comms_i2c_device3
	Under the I2C Communication Device → Add I2C Share Bus →	Use → g_comms_i2c_bus0 I2C Shared Bus
	Under the OB1203 Light/Proximity/PPG Sensor → Add IRQ Driver for measurement →	New → External IRQ
	Config for External IRQ →	Name: g_external_irq14
		Channel: 14
		Trigger: Falling

	Steps	Intermediate Steps
19b	Add the OB1203 sensor module, Proximity mode to the Oximeter Thread.	
	New Stack →	Sensor → OB1203 Light/Proximity/PPG Sensor
	Config OB1203 Light/Proximity/PPG Sensor →	Name: g_ob1203_sensor1
	Under the OB1203 Light/Proximity/PPG Sensor → Add Requires OB1203 Operation mode →	New → OB1203 Proximity mode
	Under the OB1203 Proximity mode → I2C Communication Device →	Name: g_comms_i2c_device6
	Under the I2C Communication Device → Add I2C Share Bus →	Use → g_comms_i2c_bus0 I2C Shared Bus
	Under the OB1203 Light/Proximity/PPG Sensor → Add IRQ Driver for measurement →	Use → g_external_irq14 External IRQ
20	Add Zmod Thread for ZMOD4410 IAQ sensors' handling.	
	Stacks Tab → Threads	New Thread
	Config Thread Properties →	Symbol: zmod_thread
		Name: Zmod Thread
		Stack size (bytes): 1024
		Priority: 4
Thread Context: NULL		
Memory Allocation: Static		
20a	Adding the ZMOD4XXX sensor module (ZMOD4410 IAQ) to the Zmod Thread.	
	New Stack →	Sensor → ZMOD4XXX Gas Sensor
	Config ZMOD4XXX sensor →	Name: g_zmod4xxx_sensor0
		Callback: zmod4xxx_comms_i2c_callback
		IRQ Callback: zmod4xxx_irq0_callback
	Under the ZMOD4XXX Gas Sensor → Add Requires ZMOD Library →	New → ZMOD4410 IAQ 1st Generation
	Under the ZMOD4410 IAQ 1st Generation → I2C Communication Device →	Name: g_comms_i2c_device1
	Under the I2C Communication Device → Add I2C Share Bus →	Use → g_comms_i2c_bus0 I2C Shared Bus
Under the ZMOD4XXX Gas Sensor → Add IRQ Driver for measurement [optional] →	New → External IRQ	
Config External IRQ	Name: g_external_irq0	
	Channel: 4	
	Trigger: Falling	
	Pin Interrupt Priority: Priority 3	
21	Add Console Thread	
	Stacks Tab → Threads	New Thread
	Config Thread Properties →	Symbol: console_thread
		Name: Console Thread
		Stack size (bytes): 4096
		Priority: 3
Thread Context: NULL		
Memory Allocation: Static		

	Steps	Intermediate Steps
21a	Add the UART module to Console Thread	
	New Stack →	Connectivity → UART
	Common →	FIFO Support: Enable
		DTC Support: Enable
		Flow Control Support: Enable
	Module UART → General →	Name: g_console_uart
		Channel: 5
		Data Bits: 8bits
		Parity: None
		Stop Bits: 1bit
Module UART → Baud →	Baud rate: 115200	
Module UART → Interrupts →	Callback: user_uart_callback	
Pins →	TXD5: P501	
	RXD5: P502	
	CTS5: P500	
	CTSRTS5: P508	
21b	Add Flash module to Console Thread	
	New Stack →	Storage → Flash
	Module Flash →	Name: user_flash
		Data Flash Background Operation: Disabled
		Callback: flash_callback
Flash Ready Interrupt Priority: Priority 2		
	Flash Error Interrupt Priority: Priority 2	
22	Enable “Use float with nano printf” to print float values.	
	Project → Properties → C/C++ Build → Settings → Tool Settings tab → GNU ARM Cross C Linker → Miscellaneous → Check the box	<input checked="" type="checkbox"/> Use float with nano printf (-u _printf_float)
23	Pin configuration for interrupt	
	Pins Tab → Pin Selection → Ports → P4 → P402	Mode: Disabled
	→ P403	Mode: Disabled
	→ P404	Mode: Disabled
	Pins Tab → Pin Selection → Peripherals → Input: ICU → ICU0	IRQ04: P402 IRQ14: P403 IRQ15: P404

The above configuration is a prerequisite to generate the required stack and features for the cloud connectivity application provided with this application note. Once the **Generate Project Content** button is clicked, it generates the source code for the project. The generated source code contains the required drivers, stack, and middleware. The user application files must be added into the `src` folder.

Note: `app_thread_entry.c`, `sensor_thread_entry.c`, `oximeter_thread_entry.c`, `zmod_thread_entry.c` and `console_thread_entry.c` are the auto generated files as part of the project creation. Users are required to add code to this file.

Note: To run the application with the supplied code, `app_thread_entry.c`, `sensor_thread_entry.c`, `oximeter_thread_entry.c`, `zmod_thread_entry.c` and `console_thread_entry.c` are available parts of this application note bundle can be merged or overwritten to the auto generated files.

Note: FSP generated code must be called/used from the application, while some of the middleware needs to be called exclusively as part of the application for proper initialization. For instance, the `Mbedtls_platform_setup()` call initializes the SCE and TRNG.

Note: Please change the MAC address if fail to get the Endpoint address when running this application.
Change at: Property Setting for **Ethernet** → **Module Ethernet** → **General** → **MAC address** and value of **ucMACAddress** variable in **src/usr_network.c**.

For validation of the created project, the same source files listed in section MQTT/TLS Application Software Overview (as shown in Table 3) may be added. Users are required to add the directory path and subdirectory for proper compilation. Following include paths need to be added to **Project** → **Properties** → **C/C++ Build** → **Settings** → **Tool Settings tab** → **GNU Arm Cross C Compiler** → **Includes** → **Include paths (-I)**. Refer to the enclosed project for more details.

```
"${workspace_loc}/${ProjName}/src/backoffAlgorithm}"
"${workspace_loc}/${ProjName}/src/subscription_manager}"
"${workspace_loc}/${ProjName}/src/SEGGER_RTT}"
"${workspace_loc}/${ProjName}/src/ob1203_bio/KALMAN}"
"${workspace_loc}/${ProjName}/src/ob1203_bio/SAVGOL}"
"${workspace_loc}/${ProjName}/src/ob1203_bio}"
"${workspace_loc}/${ProjName}/src/ob1203_bio/SPO2}"
```

The details of the configurator from the default settings to changed settings are described in the following sections, including the reason for the change.

4.4 MQTT/TLS Configuration

This section describes the MQTT and TLS module configuration settings that are done as part of this application example.

The following table lists changes made to a default configuration populated by the RA Configurator.

Table 5. Default Configuration for CK-RA6M5

Property	Original Value	Changed Value	Reason for Change
Application Thread			
Common → General → Use Mutexes	Disabled	Enabled	This requirement is set by the AWS IOT SDK C stack
Common → Memory Allocation → Support Dynamic Allocation	Disabled	Enabled	This requirement is set by the AWS IOT SDK C stack
Common → Memory Allocation → Total Heap Size	0	0x20000	Heap required for the FreeRTOS, AWS IOT SDK, Mbed TLS
Mbed TLS (Crypto Only)			
Platform → MBEDTLS_PLATFORM_MEMORY	Undefine	Define	This selection is required to support the MbedTLS.
General → MBEDTLS_THREADING_ALT	Undefine	Define	This selection is required to support the MbedTLS to plug in any thread library.
General → MBEDTLS_THREADING_C	Undefine	Define	This selection is required to support the MbedTLS to abstract the threading layer to allow easy plugging in any thread-library.
Public Key Cryptography (PKC) → ECC → MBEDTLS_ECDH_C	Undefine	Define	This selection is required to support the MbedTLS to enable the ECDH module.
LittleFS (Heap Selection)			
BSP → RA Common → Heap Size (bytes)	0	0x20000	Heap selection for Heap 4 and other usages with malloc.

5. Sensor Stabilization Time

This table gives the time required for the sensors to sense and provide the valid data to the users. Here you will see 2 columns, column 1 – when powered up for the first time and column 2 - after software or hard reset. If the system boots up from cold start, the time for the sensors to provide the valid data is up to (1 min – 4 hours), whereas if the system bootup from warm start, the time for the sensors to provide the valid data is up to (10 sec – 2 hours). For more details, refer to the specific sensor datasheet.

Table 6. Sensor Stabilization Time

Sensor Name	When Powered Up First Time	After Soft or Hard Reset
ZMOD4410 IAQ	Up to 1 minute	Up to 1 minute
ZMOD4510 OAQ	Up to 4 hours	Up to 2 hours
OB1203	Up to 1 minute (after placing the index finger on the sensor, it may take up to 60 seconds to sense data)	Up to 10 seconds (after placing the index finger on the sensor, it may take up to 60 seconds to sense data)
HS3001	Up to 1 minute	Up to 10 seconds
ICP	Up to 1 minute	Up to 10 seconds
ICM	Up to 1 minute	Up to 10 seconds

Note: Stabilization time of the sensor provided above is from the point of sensor initialization.

6. MQTT/TLS Module Next Steps

- For setting up a client using a device certificate signed by a preferred CA certificate, refer to the link: <https://docs.aws.amazon.com/iot/latest/developerguide/device-certs-your-own.html>
- For using a self-signed certificate to configure AWS, refer to the link: <https://developer.amazon.com/docs/custom-skills/configure-web-service-self-signed-certificate.html>

7. References

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8. Known Issues and Troubleshooting

- This section talks about the known FSP and tool related issues. More details can be found at the link: <https://github.com/renesas/fsp/issues>.
- It is recommended to use the dashboard with Microsoft edge browser, it does not work properly with Google Chrome browser.
- When running debug on e2studio, if the application is rerun multiple times, it might randomly occur issue with i2c communication of OB1203 sensor. Users need to reconnect the USB cable (J14) to reset OB1203 sensor and run the application again.

9. Debugging

Enable the `USR_LOG_LVL (LOG_DEBUG)` macro in the application project for additional information of the error during debugging.

Website and Support

Visit the following vanity URLs to learn about key elements of the RA family, download components and related documentation, and get support.

CK-RA6M5 Kit Information	renesas.com/ra/ck-ra6m5
RA Cloud Solutions	renesas.com/cloudsolutions
RA Product Information	renesas.com/ra
RA Product Support Forum	renesas.com/ra/forum
RA Flexible Software Package	renesas.com/FSP
Renesas Support	renesas.com/support

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Jun.14.22	—	Initial release
1.01	Jun.11.22	—	Minor update
1.02	Mar.15.23	—	Updated to FSP 4.2.0
1.10	Dec.22.23	—	Updated to FSP 5.0.0

Notice

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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan

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